



## Material Content Data Sheet



<b>Sales Product Name</b>		BC 846PN H6327		<b>Issued</b>		27. January 2016		
<b>MA#</b>		MA000849490						
<b>Package</b>		PG-SOT363-6-1		<b>Weight*</b>		6.28 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	arsenic	7440-38-2	0.000	0.00		15	
	noble metal	gold	7440-57-5	0.009	0.15		1459	
	inorganic material	silicon	7440-21-3	0.078	1.25	1.40	12459	13933
leadframe	inorganic material	silicon	7440-21-3	0.001	0.01		92	
	non noble metal	titanium	7440-32-6	0.003	0.05		458	
	non noble metal	chromium	7440-47-3	0.009	0.14		1376	
	non noble metal	copper	7440-50-8	2.869	45.64	45.84	456587	458513
wire	non noble metal	copper	7440-50-8	0.010	0.17	0.17	1664	1664
encapsulation	organic material	carbon black	1333-86-4	0.030	0.48		4826	
	plastics	epoxy resin	-	0.652	10.38		103756	
	inorganic material	silicondioxide	60676-86-0	2.350	37.40	48.26	374005	482587
leadfinish	non noble metal	tin	7440-31-5	0.216	3.44	3.44	34357	34357
plating	noble metal	silver	7440-22-4	0.056	0.89	0.89	8946	8946
*deviation	< 10%		Sum in total:			100.00		1000000

### Important Remarks:

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